



## 4A, 900V N-CHANNEL MOSFET

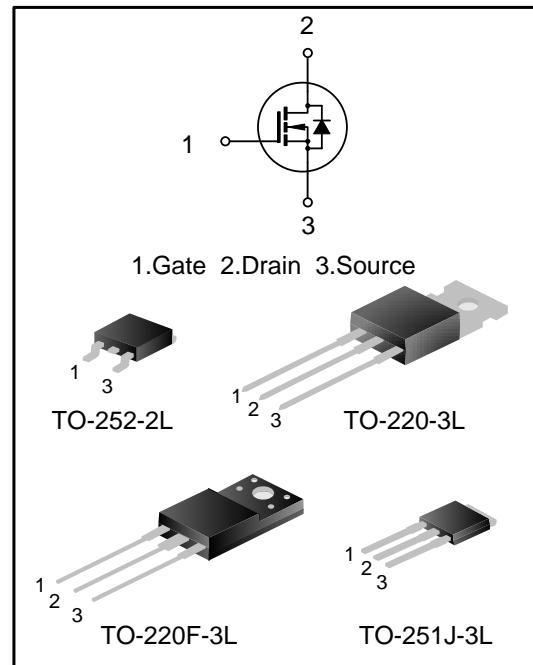
### GENERAL DESCRIPTION

SVF4N90F/MJ/T/D is an N-channel enhancement mode power MOS field effect transistor which is produced using Silan proprietary F-Cell™ high-voltage planar VDMOS technology. The improved process and cell structure have been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode.

These devices are widely used in AC-DC power supplies, DC-DC converters and H-bridge PWM motor drivers.

### FEATURES

- 4A, 900V,  $R_{DS(on)(typ.)}=2.7\Omega$  @  $V_{GS}=10V$
- Low gate charge
- Low Crss
- Fast switching
- Improved dv/dt capability



### ORDERING INFORMATION

| Part No.   | Package    | Marking  | Hazardous Substance Control | Packing Type |
|------------|------------|----------|-----------------------------|--------------|
| SVF4N90F   | TO-220F-3L | SVF4N90F | Pb free                     | Tube         |
| SVF4N90MJ  | TO-251J-3L | SVF4N90  | Halogen free                | Tube         |
| SVF4N90T   | TO-220-3L  | SVF4N90T | Pb free                     | Tube         |
| SVF4N90DTR | TO-252-2L  | SVF4N90D | Halogen free                | Tape&Reel    |



## ABSOLUTE MAXIMUM RATINGS ( $T_A=25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

| Characteristics   |                         | Symbol    | Ratings         |             |          | Unit                |
|---|-------------------------|-----------|-----------------|-------------|----------|---------------------|
|   |                         |           | SVF4N90F        | SVF4N90MJ/D | SVF4N90T |                     |
| Drain-Source Voltage  |                         | $V_{DS}$  | 900             |             |          | V                   |
| Gate-Source Voltage   |                         | $V_{GS}$  | $\pm 30$        |             |          | V                   |
| Drain Current   | $T_C=25^\circ\text{C}$  | $I_D$     | 4               |             |          | A                   |
|   | $T_C=100^\circ\text{C}$ |           | 2.5             |             |          |                     |
| Drain Current Pulsed  |                         | $I_{DM}$  | 16              |             |          | A                   |
| Power Dissipation( $T_C=25^\circ\text{C}$ )<br>-Derate above $25^\circ\text{C}$ |                         | $P_D$     | 44              | 132         | 150      | W                   |
|   |                         |           | 0.35            | 1.06        | 1.20     | W/ $^\circ\text{C}$ |
| Single Pulsed Avalanche<br>Energy (Note 1)                                      | $L=30\text{mH}$         | $E_{AS}$  | 344             |             |          | mJ                  |
|   | $L=10\text{mH}$         |           | 84              |             |          | mJ                  |
| Operation Junction Temperature Range  |                         | $T_J$     | $-55 \sim +150$ |             |          | $^\circ\text{C}$    |
| Storage Temperature Range   |                         | $T_{stg}$ | $-55 \sim +150$ |             |          | $^\circ\text{C}$    |

## THERMAL CHARACTERISTICS

| Characteristics                        |           | Symbol | Ratings  |             |          | Unit               |
|--|-----------|--------|----------|-------------|----------|--------------------|
|  |           |        | SVF4N90F | SVF4N90MJ/D | SVF4N90T |                    |
| Thermal Resistance,Junction-to-Case    | $R_{AJC}$ |        | 2.84     | 0.95        | 0.83     | $^\circ\text{C/W}$ |
| Thermal Resistance,Junction-to-Ambient | $R_{AJA}$ |        | 62.5     | 62.0        | 62.0     | $^\circ\text{C/W}$ |



## ELECTRICAL CHARACTERISTICS ( $T_j=25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

| Characteristics                          | Symbol                   | Test conditions   | Min. | Typ. | Max.      | Unit          |
|--|--------------------------|---|------|------|-----------|---------------|
| Drain -Source Breakdown Voltage          | $\text{BV}_{\text{DSS}}$ | $V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$                                      | 900  | --   | --        | V             |
| Drain-Source Leakage Current             | $I_{\text{DSS}}$         | $V_{\text{DS}}=900\text{V}, V_{\text{GS}}=0\text{V}$  | --   | --   | 1.0       | $\mu\text{A}$ |
| Gate-Source Leakage Current              | $I_{\text{GSS}}$         | $V_{\text{GS}}=\pm 30\text{V}, V_{\text{DS}}=0\text{V}$                                     | --   | --   | $\pm 100$ | nA            |
| Gate Threshold Voltage                   | $V_{\text{GS(th)}}$      | $V_{\text{GS}}=V_{\text{DS}}, I_{\text{D}}=250\mu\text{A}$                                  | 2.0  | --   | 4.0       | V             |
| Static Drain- Source On State Resistance | $R_{\text{DS(on)}}$      | $V_{\text{GS}}=10\text{V}, I_{\text{D}}=2\text{A}$  | --   | 2.7  | 3.5       | $\Omega$      |
| Input Capacitance                        | $C_{\text{iss}}$         | $V_{\text{DS}}=25\text{V}, V_{\text{GS}}=0\text{V}, f=1.0\text{MHz}$                        | --   | 707  | --        | pF            |
| Output Capacitance                       | $C_{\text{oss}}$         |   | --   | 68   | --        |               |
| Reverse Transfer Capacitance             | $C_{\text{rss}}$         |   | --   | 3.0  | --        |               |
| Turn-on Delay Time                       | $t_{\text{d(on)}}$       | $V_{\text{DD}}=450\text{V}, I_{\text{D}}=4\text{A}, R_{\text{G}}=25\Omega$<br>(Note 2,3)    | --   | 15   | --        | ns            |
| Turn-on Rise Time                        | $t_{\text{r}}$           |   | --   | 26   | --        |               |
| Turn-off Delay Time                      | $t_{\text{d(off)}}$      |   | --   | 39   | --        |               |
| Turn-off Fall Time                       | $t_{\text{f}}$           |   | --   | 28   | --        |               |
| Total Gate Charge                        | $Q_{\text{g}}$           | $V_{\text{DS}}=720\text{V}, I_{\text{D}}=4\text{A}, V_{\text{GS}}=10\text{V}$<br>(Note 2,3) | --   | 17   | --        | nC            |
| Gate-Source Charge                       | $Q_{\text{gs}}$          |   | --   | 4.1  | --        |               |
| Gate-Drain Charge                        | $Q_{\text{gd}}$          |   | --   | 7.6  | --        |               |
| Gate resistance                          | $R_{\text{G}}$           | f=1MHz, Drain Open,<br>OSC Level: 20mV  | --   | 4.2  | --        | $\Omega$      |

## SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

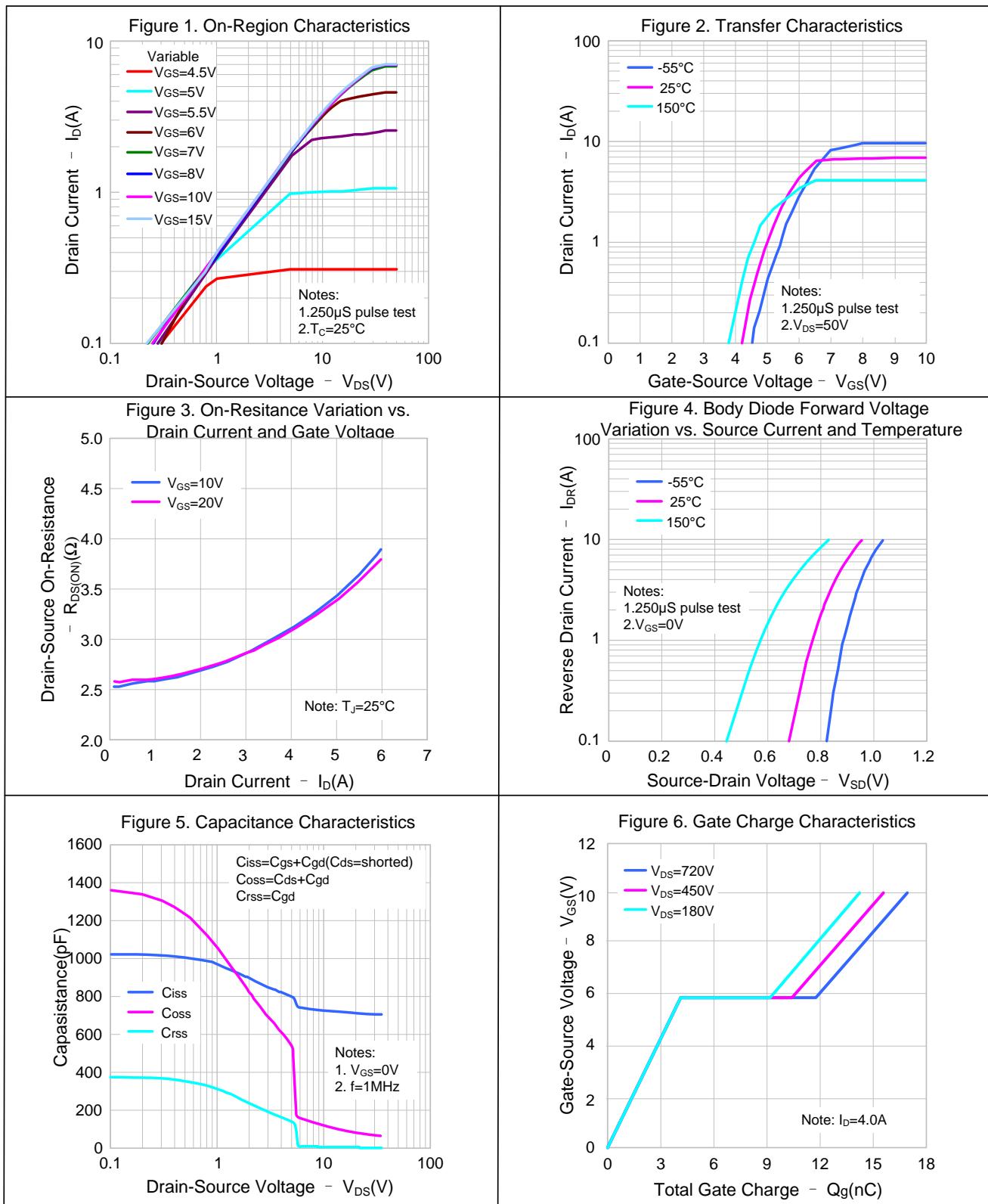
| Characteristics           | Symbol          | Test conditions  | Min. | Typ. | Max. | Unit          |
|---------------------------|-----------------|--|------|------|------|---------------|
| Continuous Source Current | $I_{\text{s}}$  | Integral Reverse P-N Junction<br>Diode in the MOSFET   | --   | --   | 4    | A             |
| Pulsed Source Current     | $I_{\text{SM}}$ |  | --   | --   | 16   |               |
| Diode Forward Voltage     | $V_{\text{SD}}$ | $I_{\text{s}}=4\text{A}, V_{\text{GS}}=0\text{V}$  | --   | --   | 1.4  | V             |
| Reverse Recovery Time     | $T_{\text{rr}}$ | $I_{\text{s}}=4\text{A}, V_{\text{GS}}=0\text{V},$<br>$dI_{\text{F}}/dt=100\text{A}/\mu\text{s}$ | --   | 535  | --   | ns            |
| Reverse Recovery Charge   | $Q_{\text{rr}}$ | (Note 2)   | --   | 2.5  | --   | $\mu\text{C}$ |

### Notes:

1.  $V_{\text{DD}}=50\text{V}, R_{\text{G}}=25\Omega$ , starting  $T_{\text{BjB}}=25^\circ\text{C}$ ;
2. Pulse Test: Pulse width  $\leq 300\mu\text{s}$ , Duty cycle  $\leq 2\%$ ;
3. Essentially independent of operating temperature.



## TYPICAL CHARACTERISTICS





## TYPICAL CHARACTERISTICS(CONTINUED)

Figure 7. Breakdown Voltage Variation vs. Temperature

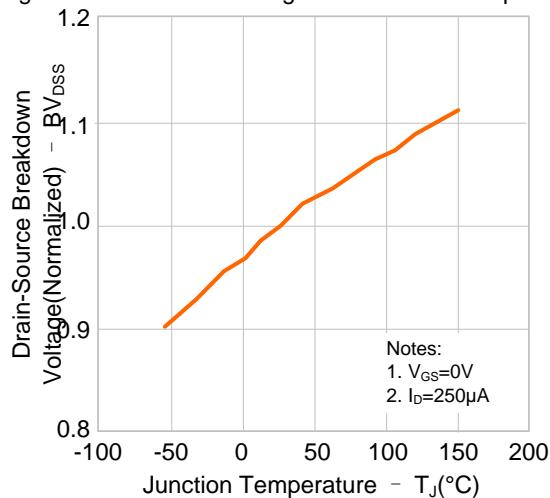


Figure 8. On-resistance Variation vs. Temperature

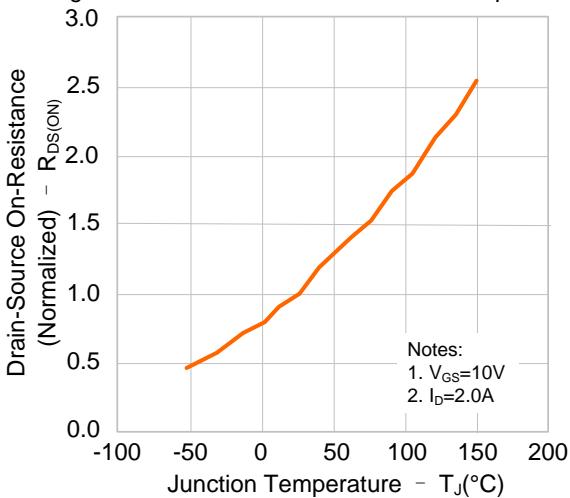


Figure 9-1. Max. Safe Operating Area(SVF4N90F)

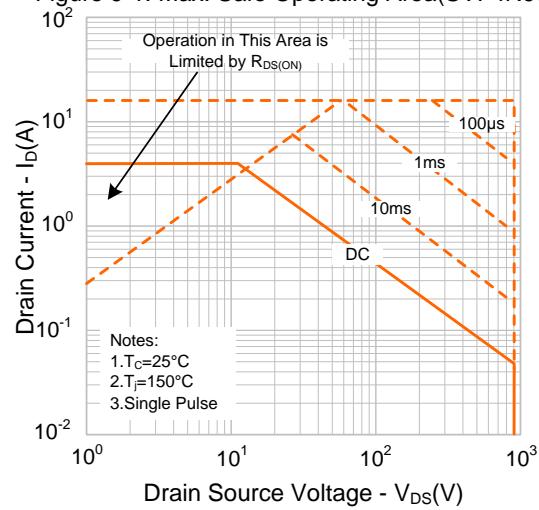


Figure 9-2. Max. Safe Operating Area(SVF4N90MJ/D)

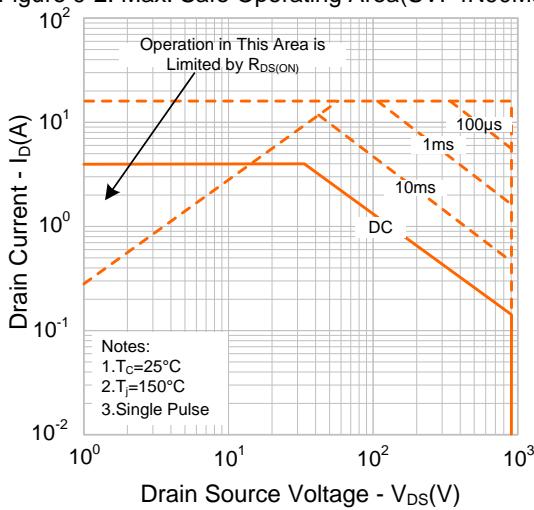


Figure 9-3. Max. Safe Operating Area(SVF4N90T)

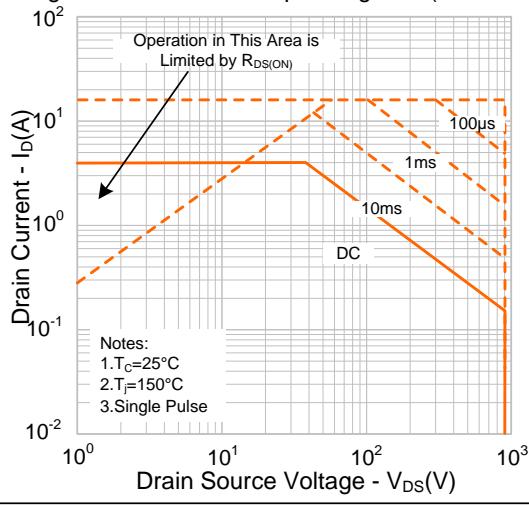
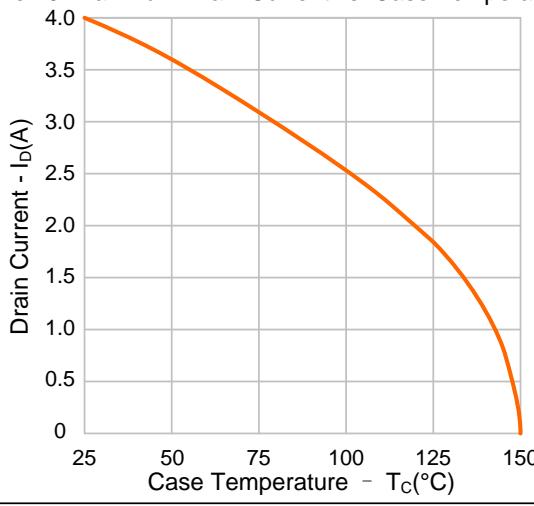


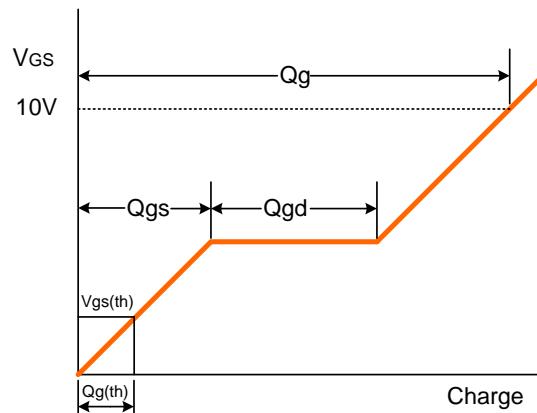
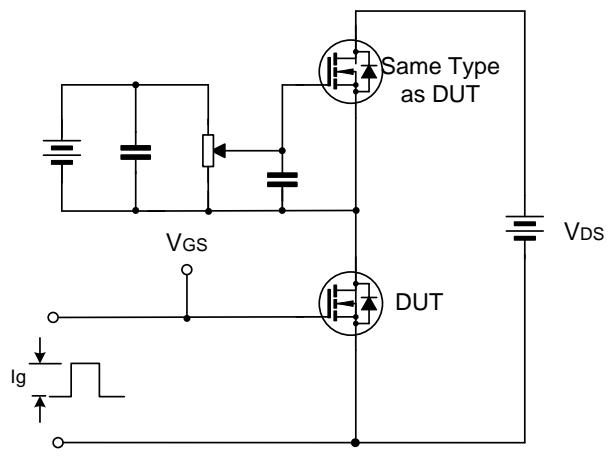
Figure 10. Maximum Drain Current vs. Case Temperature



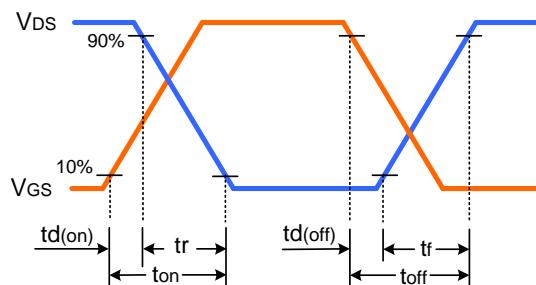
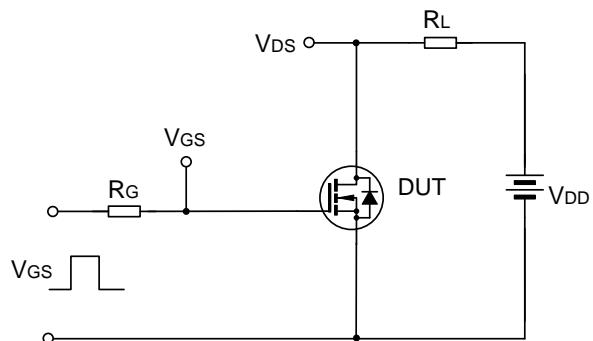


TYPICAL TEST CIRCUIT

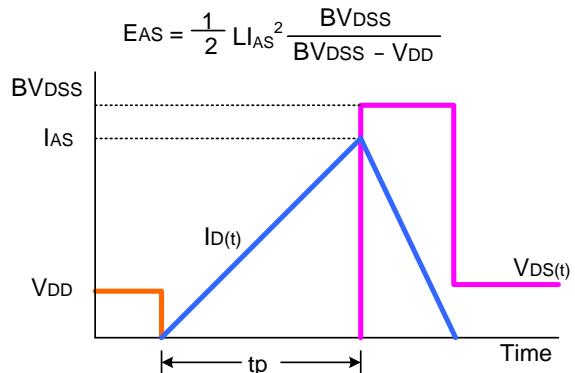
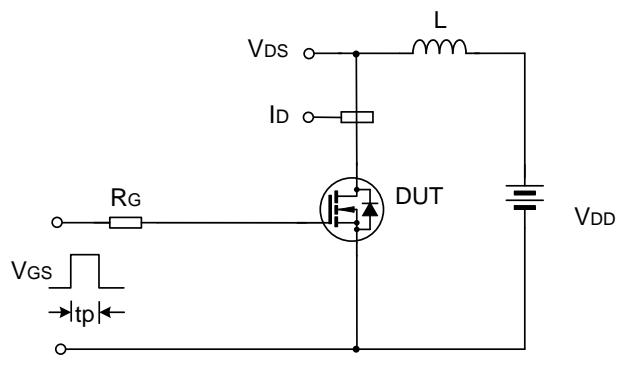
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveform



Unclamped Inductive Switching Test Circuit & Waveform

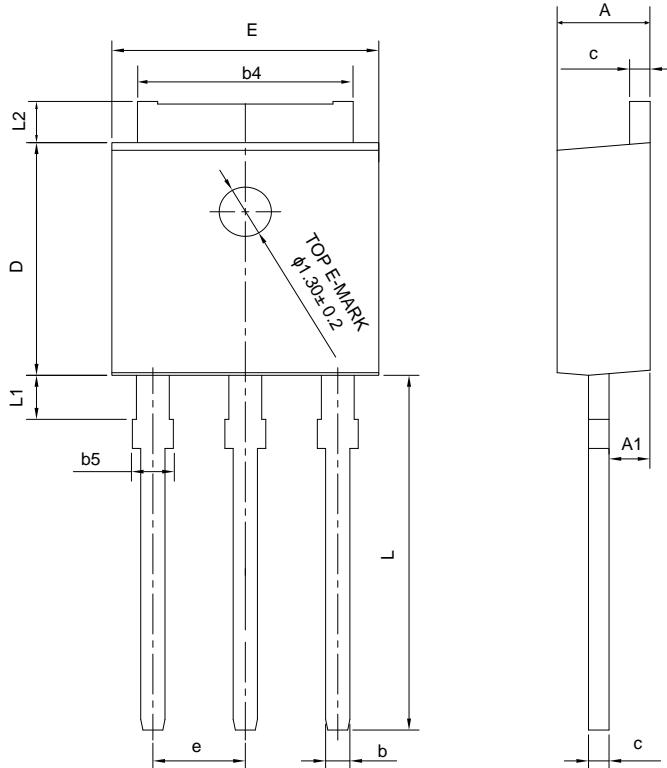




PACKAGE OUTLINE

TO-251J-3L

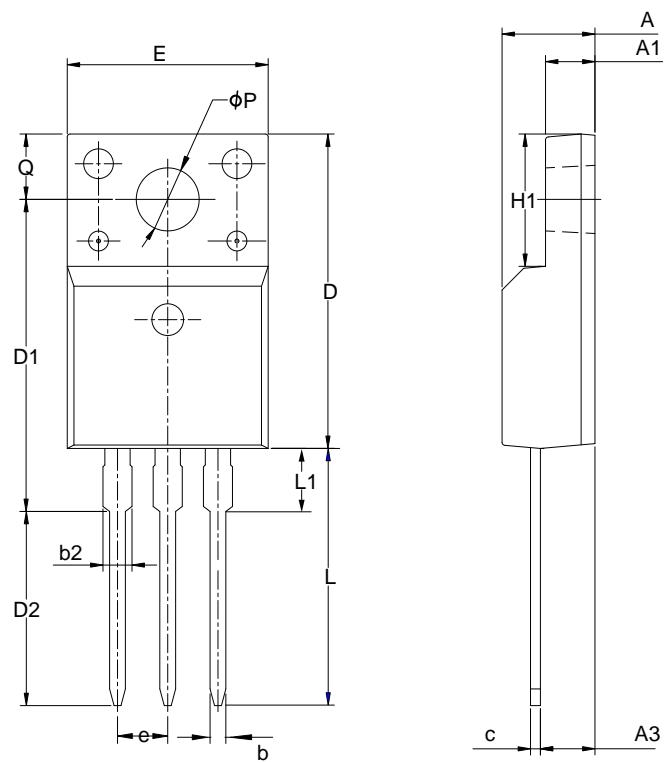
UNIT: mm



| SYMBOL | MILLIMETER |      |      |
|--------|------------|------|------|
|        | MIN        | NOM  | MAX  |
| A      | 2.18       | 2.30 | 2.39 |
| A1     | 0.89       | 1.00 | 1.14 |
| b      | 0.56       | —    | 0.89 |
| b4     | 4.95       | 5.33 | 5.46 |
| b5     | —          | —    | 1.05 |
| c      | 0.46       | —    | 0.61 |
| D      | 5.97       | 6.10 | 6.27 |
| E      | 6.35       | 6.60 | 6.73 |
| e      | 2.29 BCS   |      |      |
| L      | 8.89       | 9.30 | 9.65 |
| L1     | 0.95       | —    | 1.50 |
| L2     | 0.89       | —    | 1.27 |

TO-220F-3L

UNIT: mm



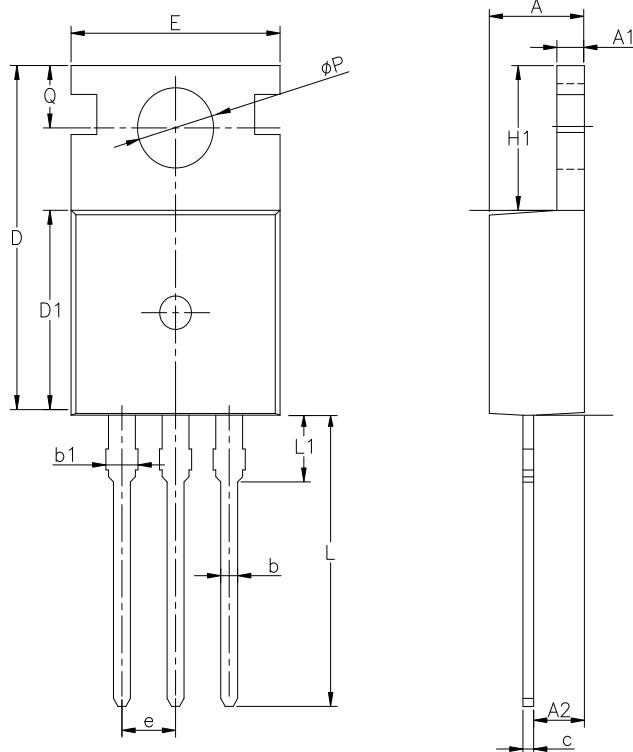
| SYMBOL | MILLIMETER |       |       |
|--------|------------|-------|-------|
|        | MIN        | NOM   | MAX   |
| A      | 4.42       | 4.70  | 5.02  |
| A1     | 2.30       | 2.54  | 2.80  |
| A3     | 2.50       | 2.76  | 3.10  |
| b      | 0.70       | 0.80  | 0.90  |
| b2     | —          | —     | 1.47  |
| c      | 0.35       | 0.50  | 0.65  |
| D      | 15.25      | 15.87 | 16.25 |
| D1     | 15.30      | 15.75 | 16.30 |
| D2     | 9.30       | 9.80  | 10.30 |
| E      | 9.73       | 10.16 | 10.36 |
| e      | 2.54BSC    |       |       |
| H1     | 6.40       | 6.68  | 7.00  |
| L      | 12.48      | 12.98 | 13.48 |
| L1     | —          | —     | 3.50  |
| φP     | 3.00       | 3.18  | 3.40  |
| Q      | 3.05       | 3.30  | 3.55  |



PACKAGE OUTLINE

TO-220-3L

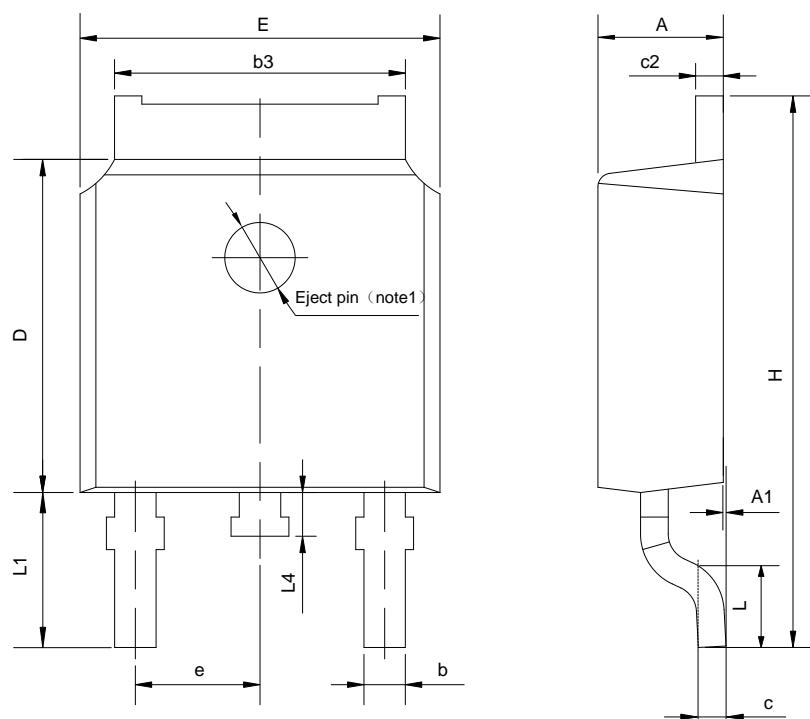
UNIT: mm



| SYMBOL | MILLIMETER |       |       |
|--------|------------|-------|-------|
|        | MIN        | NOM   | MAX   |
| A      | 4.30       | 4.50  | 4.70  |
| A1     | 1.00       | 1.30  | 1.50  |
| A2     | 1.80       | 2.40  | 2.80  |
| b      | 0.60       | 0.80  | 1.00  |
| b1     | 1.00       | —     | 1.60  |
| c      | 0.30       | —     | 0.70  |
| D      | 15.10      | 15.70 | 16.10 |
| D1     | 8.10       | 9.20  | 10.00 |
| E      | 9.60       | 9.90  | 10.40 |
| e      | 2.54BSC    |       |       |
| H1     | 6.10       | 6.50  | 7.00  |
| L      | 12.60      | 13.08 | 13.60 |
| L1     | —          | —     | 3.95  |
| φP     | 3.40       | 3.70  | 3.90  |
| Q      | 2.60       | —     | 3.20  |

TO-252-2L

UNIT: mm



| SYMBOL | MILLIMETER |       |       |
|--------|------------|-------|-------|
|        | MIN        | NOM   | MAX   |
| A      | 2.10       | 2.30  | 2.50  |
| A1     | 0          | —     | 0.127 |
| b      | 0.66       | 0.76  | 0.89  |
| b3     | 5.10       | 5.33  | 5.46  |
| c      | 0.45       | —     | 0.65  |
| c2     | 0.45       | —     | 0.65  |
| D      | 5.80       | 6.10  | 6.40  |
| E      | 6.30       | 6.60  | 6.90  |
| e      | 2.30TYP    |       |       |
| H      | 9.60       | 10.10 | 10.60 |
| L      | 1.40       | 1.50  | 1.70  |
| L1     | 2.90REF    |       |       |
| L4     | 0.60       | 0.80  | 1.00  |



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- The instructions are subject to change without notice! Customers should obtain the latest relevant information before placing orders and should verify that such information is complete and current.
- Our products are consumer electronic products, and / or civil electronic products.
- When using our products, please do not exceed the maximum rating of the products, otherwise the reliability of the whole machine will be affected. There is a certain possibility of failure or malfunction of any semiconductor product under specific conditions. The buyer is responsible for complying with safety standards and taking safety measures when using our products for system design, sample and whole machine manufacturing, so as to avoid potential failure risk that may cause personal injury or property loss.
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- Website: <http://www.silan.com.cn>

|            |   |                |   |
|------------|---|----------------|---|
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| Copyright: | HANGZHOU SILAN MICROELECTRONICS CO.,LTD | Website:       | <a href="http://www.silan.com.cn">http://www.silan.com.cn</a> |

Rev.: 2.2

Revision History:

1. Update the template of the datasheet

Rev.: 2.1

Revision History:

1. Add the EAS value under L=10mH

Rev.: 2.0

Revision History:

1. Add the package outline of TO-252-2L

Rev.: 1.9

Revision History:

1. Add another space figure of TO-220-3L

Rev.: 1.8

Revision History:

1. Add TO-220-3L

Rev.: 1.7

Revision History:

1. Update the package outline of TO-251J-3L

Rev.: 1.6

Revision History:

1. Modify the package information of TO-220F-3L

Rev.: 1.5

Revision History:

1. Modify the thermal characteristics

Rev.: 1.4

Revision History:

1. Add the package of TO-251J-3L



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Rev.: **1.3**

Revision History:

1. Modify the ordering information
- 

Rev.: **1.2**

Revision History:

1. Change the schematic diagram of MOS
- 

Rev.: **1.1**

Revision History:

1. Modify "PACKAGE OUTLINE"
- 

Rev.: **1.0**

Revision History:

1. Initial release
- 
-